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Renesas Electronics Corporation

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Application Note

78K0S/Kx1+

Sample Program (A/D Converter)

Successive A/D Conversion & Average Value Calculation

This document describes an operation overview of the sample program and how to use it, as well as how to set and use the A/D converter. In the sample program, A/D conversion is performed four times each for the analog input from the ANI0 pin and ANI1 pin, and each converted data and the average value of the converted data are saved into the RAM area.

Target devices

- 78K0S/KA1+ microcontroller
- 78K0S/KB1+ microcontroller
- 78K0S/KU1+ microcontroller
- 78K0S/KY1+ microcontroller

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CHAPTER 1 OVERVIEW

An example of using the A/D converter is presented in this sample program. A/D conversion is performed four times each for the analog input from the ANI0 pin and ANI1 pin, and each converted data and the average value of the converted data are saved into the RAM area.

1.1 Main Contents of the Initial Settings

The main contents of the initial settings are as follows.

- Selecting the high-speed internal oscillator as the system clock source^{Note}
- Stopping watchdog timer operation
- Setting V_{LVI} (low-voltage detection voltage) to $4.3\text{ V} \pm 0.2\text{ V}$
- Generating an internal reset (LVI reset) signal when it is detected that V_{DD} is less than V_{LVI} , after V_{DD} (power supply voltage) becomes greater than or equal to V_{LVI}
- Setting the CPU clock frequency to 8 MHz
- Setting the I/O ports
- Setting the A/D converter
 - Setting the A/D conversion time to $72/f_{XP}$ ($9.0\ \mu\text{s}$)

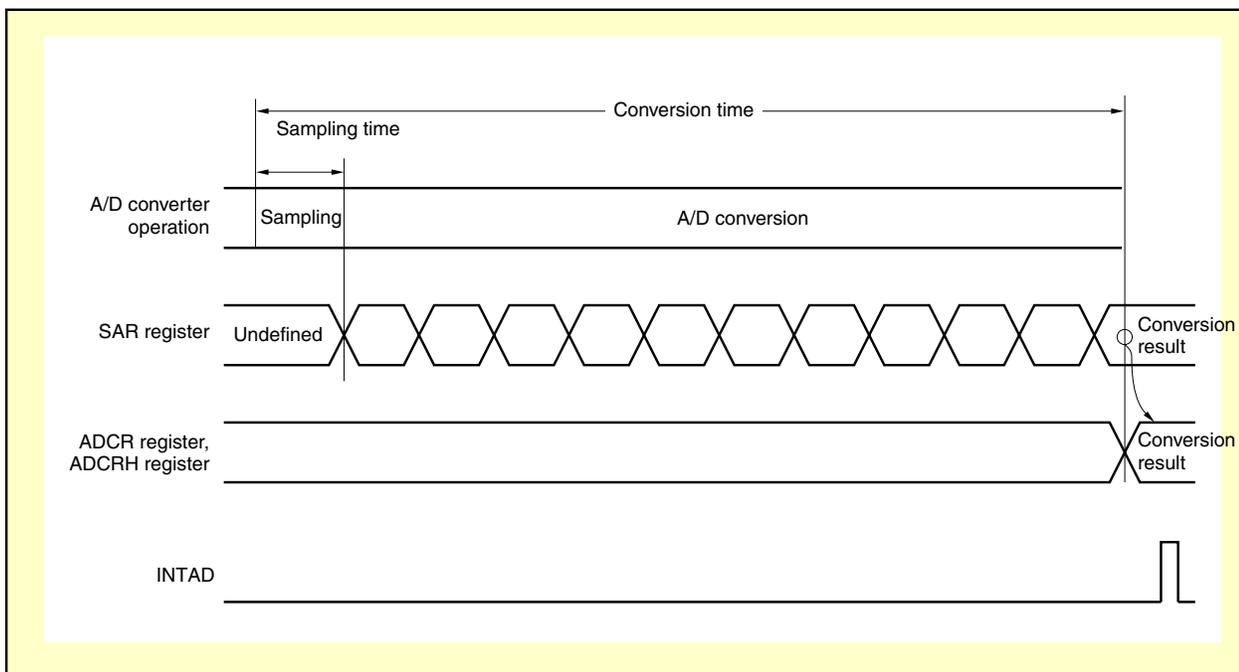
Note This is set by using the option byte.

1.2 Contents Following the Main Loop

After completion of the initial settings, A/D conversion operation is started whereupon A/D conversion is performed four times for the analog input from the ANI0 pin and the converted data is saved into the RAM area. A/D conversion operation is stopped after the same processing is performed for the analog input from the ANI1 pin. After A/D conversion operation is stopped, the average value of the four A/D conversions performed is calculated for the ANI0 pin and for the ANI1 pin, and the average values are saved into the RAM area.

After completion of the initial settings, successive four-time A/D conversion processing (2 ch) and average value calculation processing (2 ch), as mentioned above, are repeated. In this manner, the effects of variation in the analog inputs can be suppressed by performing A/D conversion multiple times and using the average values calculated from the converted data. Furthermore, power consumption can be reduced by stopping A/D conversion operation when calculating the average values.

Figure 1-1. Basic A/D Converter Operation (A/D Conversion: 1 Time)



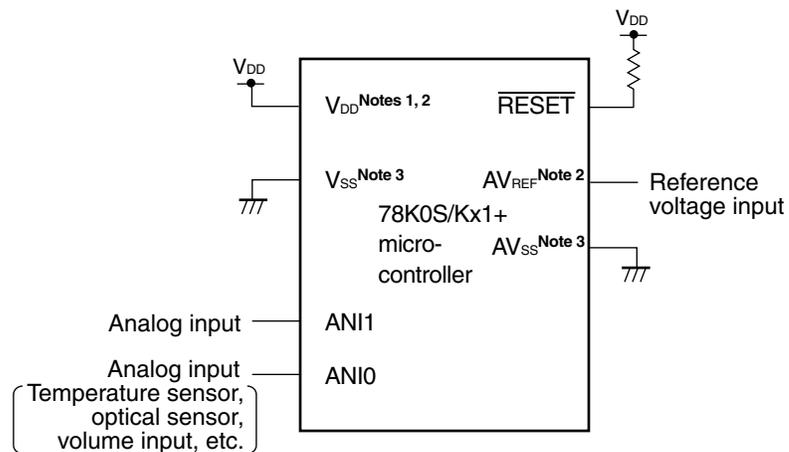
Caution For cautions when using the device, refer to the user's manual of each product ([78K0S/KU1+](#), [78K0S/KY1+](#), [78K0S/KA1+](#), [78K0S/KB1+](#)).

CHAPTER 2 CIRCUIT DIAGRAM

This chapter describes a circuit diagram to be used in this sample program.

2.1 Circuit Diagram

A circuit diagram is shown below.



Notes 1. Use this in a voltage range of $4.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$.

2. V_{DD} of the 78K0S/KU1+ and 78K0S/KY1+ microcontrollers is used alternatively as the reference voltage input (AV_{REF}) of the A/D converter. Make sure that the A/D converter stabilizes at the power supply voltage to be used when using the A/D converter.

3. V_{SS} of the 78K0S/KA1+, 78K0S/KU1+, and 78K0S/KY1+ microcontrollers is used alternatively as the ground potential (AV_{SS}) of the A/D converter. Make sure to connect V_{SS} to a stabilized GND (= 0 V).

Caution Leave all unused pins open (unconnected), except for the pins shown in the circuit diagram.

CHAPTER 3 SOFTWARE

This chapter describes the file configuration of the compressed file to be downloaded, internal peripheral functions of the microcontroller to be used, and initial settings and operation overview of the sample program, and shows a flow chart.

3.1 File Configuration

The following table shows the file configuration of the compressed file to be downloaded.

File Name	Description	Compressed (*.zip) File Included		
				
main.asm (Assembly language version) ----- main.c (C language version)	Source file for hardware initialization processing and main processing of microcontroller	● Note 1	● Note 1	
op.asm	Assembler source file for setting the option byte (sets the system clock source)	●	●	
ad.prw	Work space file for integrated development environment PM+		●	
ad.prj	Project file for integrated development environment PM+		●	
ad.pri ad.prs ad.prm	Project files for system simulator SM+ for 78K0S/Kx1+		● Note 2	
ad0.pnl	I/O panel file for system simulator SM+ for 78K0S/Kx1+ (used for checking peripheral hardware operations)		● Note 2	●

- Notes 1.** “main.asm” is included with the assembly language version, and “main.c” with the C language version.
2. These files are not included among the files for the 78K0S/KU1+ microcontroller.

Remark



: Only the source file is included.



: The files to be used with integrated development environment PM+ and 78K0S/Kx1+ system simulator SM+ are included.



: The microcontroller operation simulation file to be used with system simulator SM+ for 78K0S/Kx1+ is included.

3.2 Internal Peripheral Functions to Be Used

The following internal peripheral functions of the microcontroller are used in this sample program.

- 10-bit resolution A/D conversion: A/D converter
- $V_{DD} < V_{LVI}$ detection: Low-voltage detector (LVI)
- Analog input: ANI0, ANI1 (analog input ports)

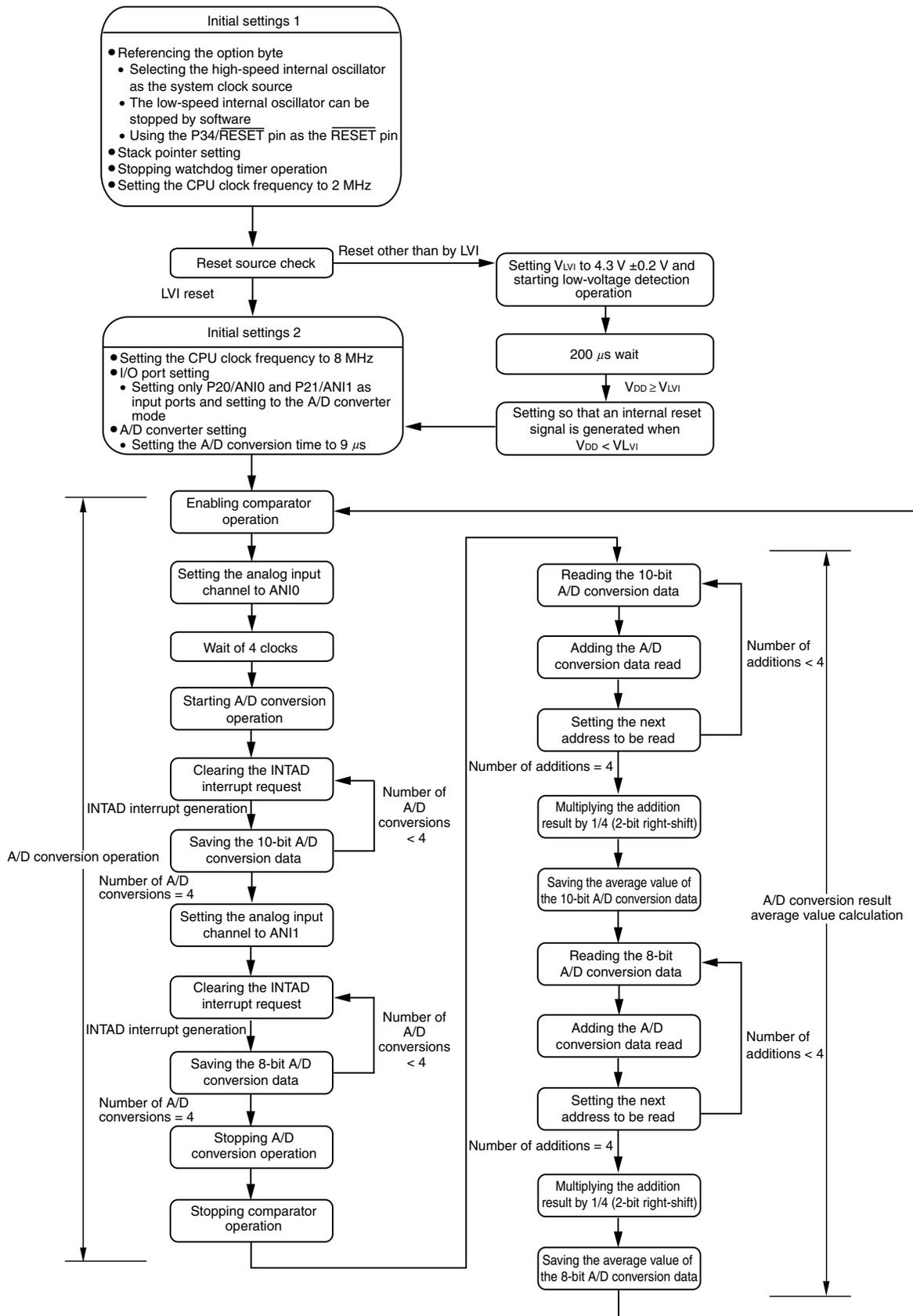
3.3 Initial Settings and Operation Overview

In this sample program, initial settings including the setting of the low-voltage detection function, selection of the clock frequency, setting of the I/O ports, and setting of the A/D converter are performed.

After completion of the initial settings, A/D conversion operation is started whereupon A/D conversion is performed four times for the analog input from the ANI0 pin and the converted data is saved into the RAM area. A/D conversion operation is stopped after the same processing is performed for the analog input from the ANI1 pin. After A/D conversion operation is stopped, the average value of the four A/D conversions performed is calculated for the ANI0 pin and for the ANI1 pin, and the average values are saved into the RAM area.

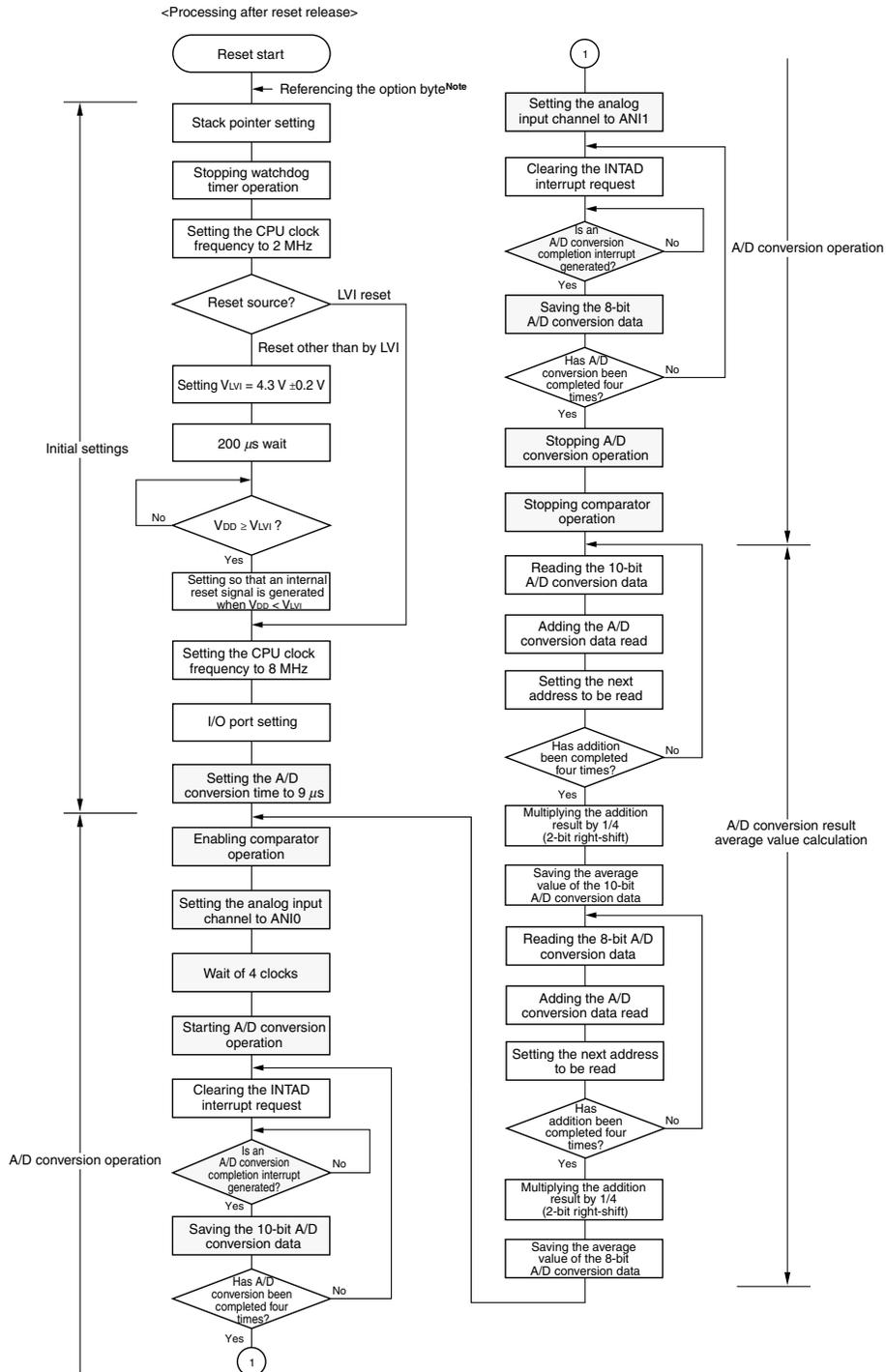
After completion of the initial settings, successive four-time A/D conversion processing (2 ch) and average value calculation processing (2 ch), as mentioned above, are repeated. In this manner, the effects of variation in the analog inputs can be suppressed by performing A/D conversion multiple times and using the average values calculated from the converted data. Furthermore, power consumption can be reduced by stopping A/D conversion operation when calculating the average values.

The details are described in the status transition diagram shown below.



3.4 Flow Charts

The flow charts for the sample program are shown below.



Note Referencing the option byte is automatically performed by the microcontroller after reset release. In this sample program, the following contents are set by referencing the option byte.

- Using the high-speed internal oscillation clock (8 MHz (TYP.)) as the system clock source
- The low-speed internal oscillator can be stopped by using software
- Using the P34/ $\overline{\text{RESET}}$ pin as the $\overline{\text{RESET}}$ pin

CHAPTER 4 SETTING METHODS

This chapter describes the A/D converter setting.

For other initial settings, refer to the [78K0S/Kx1+ Sample Program \(Initial Settings\) LED Lighting Switch Control Application Note](#). For interrupt, refer to the [78K0S/Kx1+ Sample Program \(Interrupt\) External Interrupt Generated by Switch Input Application Note](#). For low-voltage detection (LVI), refer to the [78K0S/Kx1+ Sample Program \(Low-Voltage Detection\) Reset Generation During Detection at Less than 2.7 V Application Note](#).

For how to set registers, refer to the user's manual of each product ([78K0S/KU1+](#), [78K0S/KY1+](#), [78K0S/KA1+](#), [78K0S/KB1+](#)).

For assembler instructions, refer to the [78K/0S Series Instructions User's Manual](#).

4.1 Setting the A/D Converter

The A/D converter uses the following six registers.

- A/D converter mode register (ADM)
- Analog input channel specification register (ADS)
- 10-bit A/D conversion result register (ADCR)
- 8-bit A/D conversion result register (ADCRH)
- Port mode register x (PMx)
- Port mode control register x (PMCx)

<Example of the procedure for setting the basic A/D converter operation>

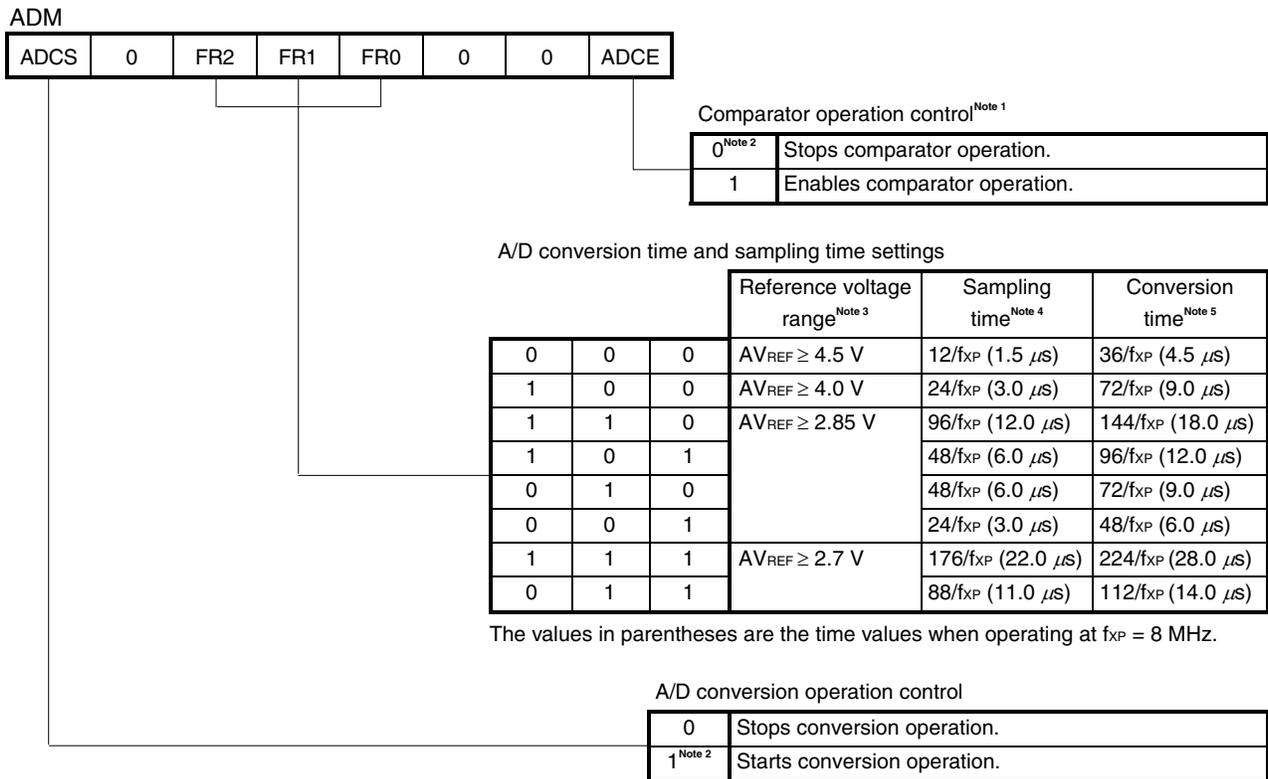
- <1> Using the FR2 to FR0 bits to set the A/D conversion time
- <2> Setting (1) the ADCE bit
- <3> Using the ADS register to set the analog input channel
- <4> Waiting for four clocks (executing two NOP instructions or an instruction equivalent to two machine cycles)
- <5> Setting (1) the ADCS bit: starting A/D conversion operation

- Cautions**
1. Steps <1> to <3> may be performed randomly.
 2. Leave an interval of at least 1 μs between steps <2> and <5>.

(1) ADM register setting

This register sets the conversion time for the analog input to be A/D converted, and starts or stops conversion operation.

Figure 4-1. Format of A/D Converter Mode Register (ADM)



- Remarks**
1. f_{XP} : Oscillation frequency of the clock supplied to peripheral hardware
 2. The conversion time refers to the total of the sampling time and the time from successively comparing the sampling value until the conversion result is output.

(Notes and Cautions are given on the next page.)

Notes 1. The operation of the comparator is controlled by ADCS and ADCE, and the time from starting the operation until it stabilizes takes 1 μs . The conversion data, therefore, becomes valid starting from the first conversion data, by setting ADCS to 1 after at least 1 μs elapses since ADCE was set to 1. If ADCS is set to 1 without waiting for at least 1 μs , ignore the first conversion data.

Table 4-1. ADCS and ADCE Settings

ADCS	ADCE	A/D Conversion Operation
0	0	Stopped (No DC power consumption path exists.)
0	1	Conversion wait mode (Only the comparator consumes power.)
1	×	Conversion mode

- Even when ADCE is 0 (comparator operation is stopped), A/D conversion operation starts if ADCS is set to 1. Ignore the first conversion data, however, because it is outside the guaranteed-value range.
- Be sure to set FR2, FR1, and FR0 in accordance with the reference voltage range, so that Notes 4 and 5, below, are satisfied.

Example: When $AV_{REF} \geq 2.7\text{ V}$, $f_{XP} = 8\text{ MHz}$

- The sampling time is at least 11.0 μs , and the A/D conversion time is at least 14.0 μs and less than 100 μs .
- Set FR2, FR1, and FR0 to 0, 1, 1 or 1, 1, 1.

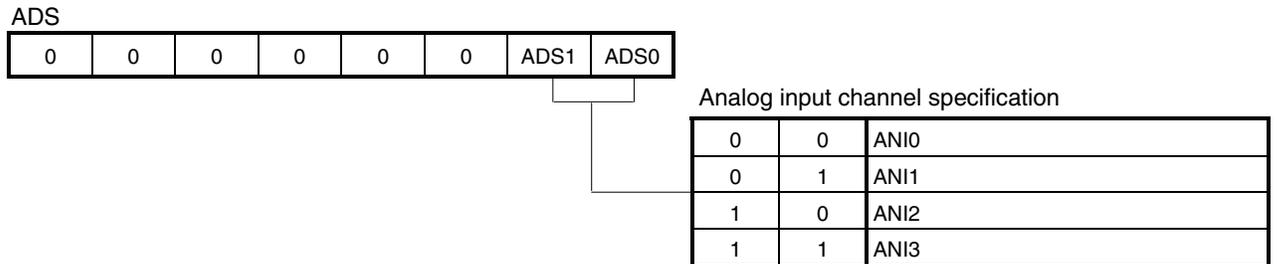
- Set the sampling time as follows.
 - $AV_{REF} \geq 4.5\text{ V}$: At least 1.0 μs
 - $AV_{REF} \geq 4.0\text{ V}$: At least 2.4 μs
 - $AV_{REF} \geq 2.85\text{ V}$: At least 3.0 μs
 - $AV_{REF} \geq 2.7\text{ V}$: At least 11.0 μs
- Set the A/D conversion time as follows.
 - $AV_{REF} \geq 4.5\text{ V}$: At least 3.0 μs and less than 100 μs
 - $AV_{REF} \geq 4.0\text{ V}$: At least 4.8 μs and less than 100 μs
 - $AV_{REF} \geq 2.85\text{ V}$: At least 6.0 μs and less than 100 μs
 - $AV_{REF} \geq 2.7\text{ V}$: At least 14.0 μs and less than 100 μs

- Cautions**
- The above sampling times and conversion times do not include clock frequency errors. Select sampling time and conversion time that satisfy the conditions described in Notes 4 and 5, in consideration of clock frequency errors (an error margin of maximum $\pm 5\%$ when using the high-speed internal oscillator).
 - To start A/D conversion after a bit other than ADCS of ADM is manipulated while A/D conversion is stopped (ADCS = 0), set ADCS to 1 after executing two NOP instructions or an instruction equivalent to two machine cycles.
 - Stop A/D conversion (ADCS = 0) before rewriting bits FR0 to FR2.
 - Be sure to clear bits 6, 2, and 1 to "0".

(2) ADS register setting

This register specifies the input port of the analog voltage to be A/D converted.

Figure 4-2. Format of Analog Input Channel Specification Register (ADS)

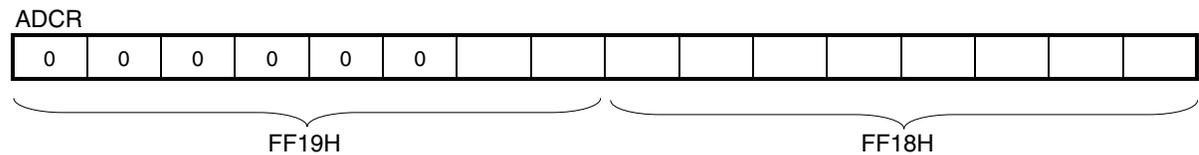


Caution Be sure to clear bits 2 to 7 to “0”.

(3) ADCR register operation

This register is a read-only 16-bit register that retains the A/D conversion result. The higher six bits are fixed to 0. Each time A/D conversion ends, the conversion result is loaded from the successive approximation register, and is stored into ADCR, in the order starting from bit 1 of FF19H. FF19H indicates the higher 2 bits of the conversion result, and FF18H indicates the lower 8 bits of the conversion result.

Figure 4-3. Format of 10-bit A/D Conversion Result Register (ADCR)



Caution When the ADM and ADS registers have been written, the contents of the ADCR register may become undefined. Read the conversion result before writing to the ADM and ADS registers, after completion of conversion operation. A correct conversion result may not be read at a timing other than that mentioned above.

(4) ADCRH register operation

This register is a read-only 8-bit register that retains the A/D conversion result. It stores the higher 8 bits of a 10-bit resolution result.

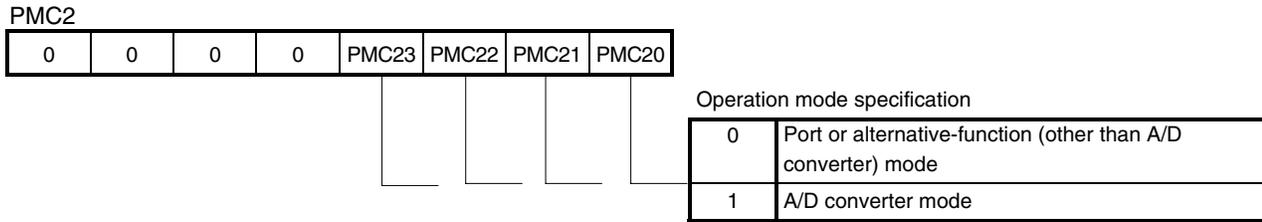
Figure 4-4. Format of 8-bit A/D Conversion Result Register (ADCRH)



(5) **PMC2 register and PM2 register settings**

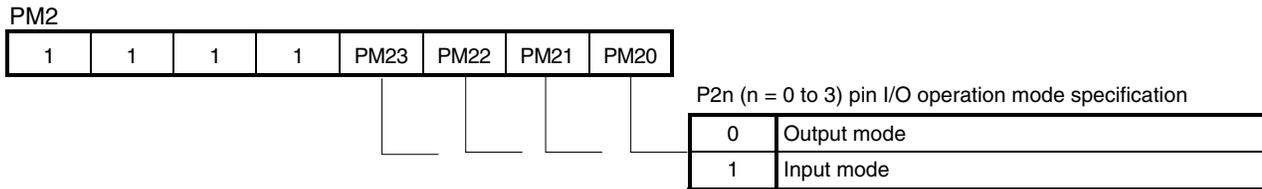
When using the ANI0/P20 to ANI3/P23 pins as analog inputs, set PMC20 to PMC23 and PM20 to PM23 to 1.

Figure 4-5. Format of Port Mode Control Register 2 (PMC2)



Caution When PMC20 to PMC23 are set to 1, the P20/ANI0 to P23/ANI3 pins cannot be used as port pins. Be sure to set the pull-up resistor option registers (PU20 to PU23) to 0 for the pins set to the A/D converter mode.

Figure 4-6. Format of Port Mode Register 2 (PM2)



[Example] When starting A/D conversion operation by setting the analog input channel to ANI0 and the A/D conversion time to 9 μs
(Oscillation frequency of the clock supplied to peripheral hardware (f_{XP}) = 8 MHz)
(Same contents as in this sample program source)

(1) Register settings

<1> ADM



Comparator operation control

0	Stops comparator operation.
1	Enables comparator operation.

A/D conversion time and sampling time settings

	Reference voltage range	Sampling time	Conversion time
1 0 0	$AV_{REF} \geq 4.0 \text{ V}$	$24/f_{XP}$ (3.0 μs)	$72/f_{XP}$ (9.0 μs)

The values in parentheses are the time values when operating at $f_{XP} = 8 \text{ MHz}$.

A/D conversion operation control

0	Stops conversion operation.
1	Starts conversion operation.

<2> ADS



Analog input channel specification

0	0	ANI0
---	---	------

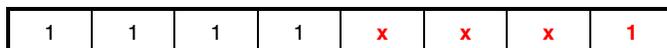
<3> PMC2



Operation mode specification

1	A/D converter mode
---	--------------------

<4> PM2



P2n (n = 0 to 3) pin I/O operation mode specification

1	Input mode
---	------------

(2) Sample program

<1> Assembly language

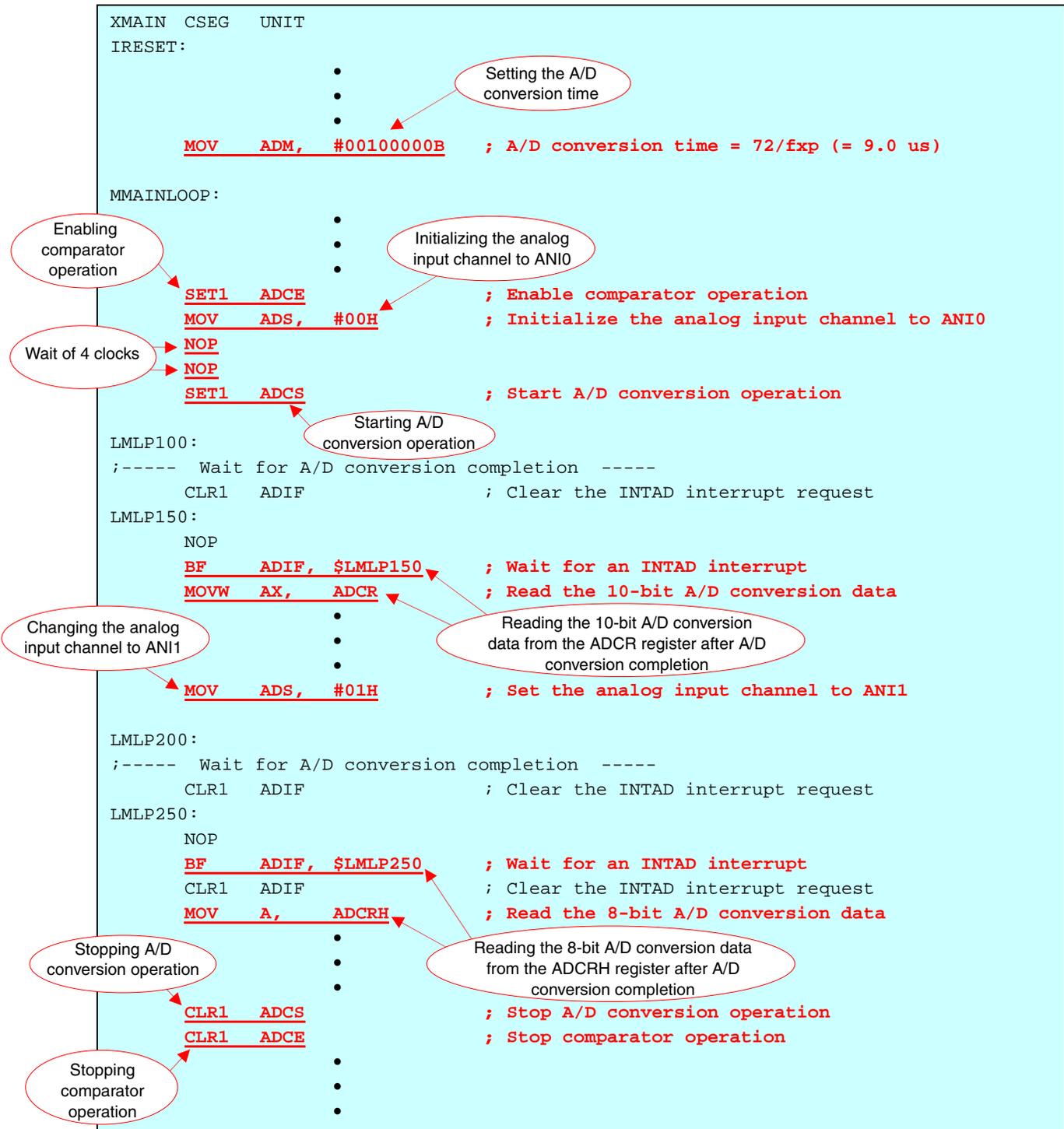
```
SET1  PMC2.0
SET1  PM2.0
MOV   ADM,  #00100000B
SET1  ADCE
MOV   ADS,  #00H
NOP
NOP
SET1  ADCS
```

<2> C language

```
PMC2.0 = 1;
PM2.0 = 1;
ADM = 0b00100000;
ADCE = 1;
ADS = 0x00;
NOP();
NOP();
ADCS = 1;
```

[Excerpt from this sample program source]

An excerpt from [APPENDIX A PROGRAM LIST](#), which is related to the A/D converter function, is shown below (same contents as in [\[Example\]](#) mentioned above).

(1) Assembly language

(2) C language

```

void hdwinit(void){
    unsigned char ucCnt200us; /* 8-bit variable for 200 us wait */
        .
        .
        .
    ADM = 0b00100000; /* A/D conversion time = 72/fxp (= 9.0 us) */
    return;
}

void main(void){
        .
        .
        .
    Enable comparator operation → ADCE = 1; /* Enable comparator operation */
    Initialize the analog input channel to ANI0 → ADS = 0x00; /* Initialize the analog input channel to ANI0 */
    /*
    Wait of 4 clocks → NOP();
    → NOP();
    Starting A/D conversion operation → ADCS = 1; /* Start A/D conversion operation */ /*INTMO = 0b00000000;

    for (ucTimes = 0; ucTimes < 4; ucTimes++) /* Perform A/D conversion processing four times */
    {
        ADIF = 0; /* Clear the INTAD interrupt request */

        while (!ADIF) /* Wait for an INTAD interrupt */
        {
            NOP();
        }
        g_ushnAdBuff0[ucTimes] = ADCR; /* Store the 10-bit A/D conversion data */
    }
    Changing the analog input channel to ANI1 → ADS = 0x01; /* Set the analog input channel to ANI1 */

    for (ucTimes = 0; ucTimes < 4; ucTimes++) /* Perform A/D conversion processing four times */
    {
        ADIF = 0; /* Clear the INTAD interrupt request */
        while (!ADIF) /* Wait for an INTAD interrupt */
        {
            NOP();
        }
        g_ucAdBuff1[ucTimes] = ADCRH; /* Store the 8-bit A/D conversion data */
    }

    Stopping A/D conversion operation → ADCS = 0; /* Stop A/D conversion operation */
    → ADCE = 0; /* Stop comparator operation */
    Stopping comparator operation
        .
        .
        .

```

4.2 Input Voltage and A/D Conversion Result

The analog input voltage input from the analog input pins (ANI0 to ANI3) and the theoretical A/D conversion result (ADCR register)^{Note} have a relation expressed by the following expression.

- ADCR register (10-bit resolution)

$$\text{ADCR} = \text{INT} \left(\frac{V_{\text{AIN}}}{V_{\text{REF}}} \times 1024 + 0.5 \right)$$

or

$$\left(\text{ADCR} - 0.5 \right) \times \frac{V_{\text{REF}}}{1024} \leq V_{\text{AIN}} < \left(\text{ADCR} + 0.5 \right) \times \frac{V_{\text{REF}}}{1024}$$

Remark INT (): Function returning the integral part of the value within parentheses

V_{AIN} : Analog input voltage

V_{REF} : V_{REF} pin voltage

ADCR: 10-bit A/D conversion result register (ADCR) value

Calculation example: When the analog input voltage is 1.96 V and the V_{REF} pin voltage is 5 V

- $\text{ADCR} = \text{INT} \left(\frac{1960}{5000} \times 1024 + 0.5 \right) = \text{INT} (401.908) = 401 = 0191\text{H}$

Note There are two types of A/D conversion result registers.

- ADCR register: Stores the A/D conversion result (10-bit resolution)
- ADCRH register: Stores the higher 8 bits of the A/D conversion result (10-bit resolution)

CHAPTER 5 OPERATION CHECK USING SYSTEM SIMULATOR SM+

This chapter describes how the sample program operates with system simulator SM+ for 78K0S/Kx1+, by using the assembly language file (source files + project file) that has been downloaded by selecting the  icon.

<R> **Caution** System simulator SM+ for 78K0S/Kx1+ is not supported with the 78K0S/KU1+ microcontroller (as of July 2008). The operation of the 78K0S/KU1+ microcontroller, therefore, cannot be checked by using system simulator SM+ for 78K0S/Kx1+.

<R> 5.1 Building the Sample Program

To check the operation of the sample program by using system simulator SM+ for 78K0S/Kx1+ (hereinafter referred to as “SM+”), SM+ must be started after building the sample program. This section describes how to build a sample program by using the assembly language sample program (source program + project file) downloaded by clicking the  icon. See the [78K0S/Kx1+ Sample Program Startup Guide Application Note](#) for how to build other downloaded programs.

For the details of how to operate PM+, refer to the [PM+ Project Manager User's Manual](#).



[Column] Build errors

Change the compiler option setting according to the following procedure when the error message “A006 File not found ‘C:\NECTOOLS32\LIB78K0S\sl.rel’” or “*** ERROR F206 Segment ‘@@DATA’ can’t allocate to memory - ignored.” is displayed, when building with PM+.

<1> Select [Compiler Options] from the [Tool] menu.

<2> The [Compiler Options] dialog box will be displayed. Select the [Startup Routine] tab.

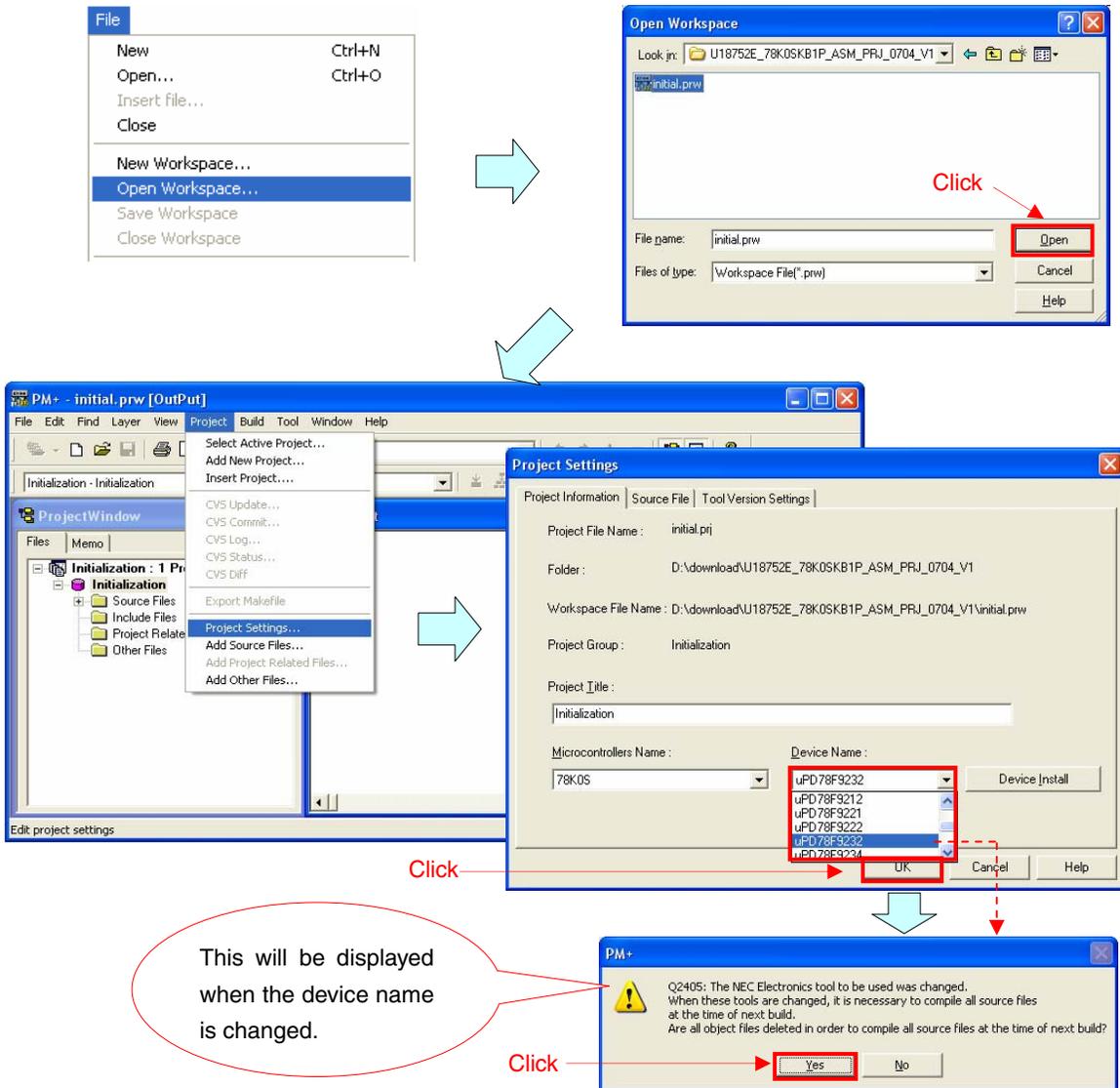
<3> Uncheck the [Using Fixed Area of Standard Library] check box. (Leave the other check boxes as they are.)

A RAM area of 118 bytes that has been secured as a fixed standard library area will be enabled for use when the [Using Fixed Area of Standard Library] check box is unchecked; however, the standard libraries (such as the getchar function and malloc function) will be disabled for use.

The [Using Fixed Area of Standard Library] check box is unchecked by default when the file that has been downloaded by clicking the  icon is used in this sample program.

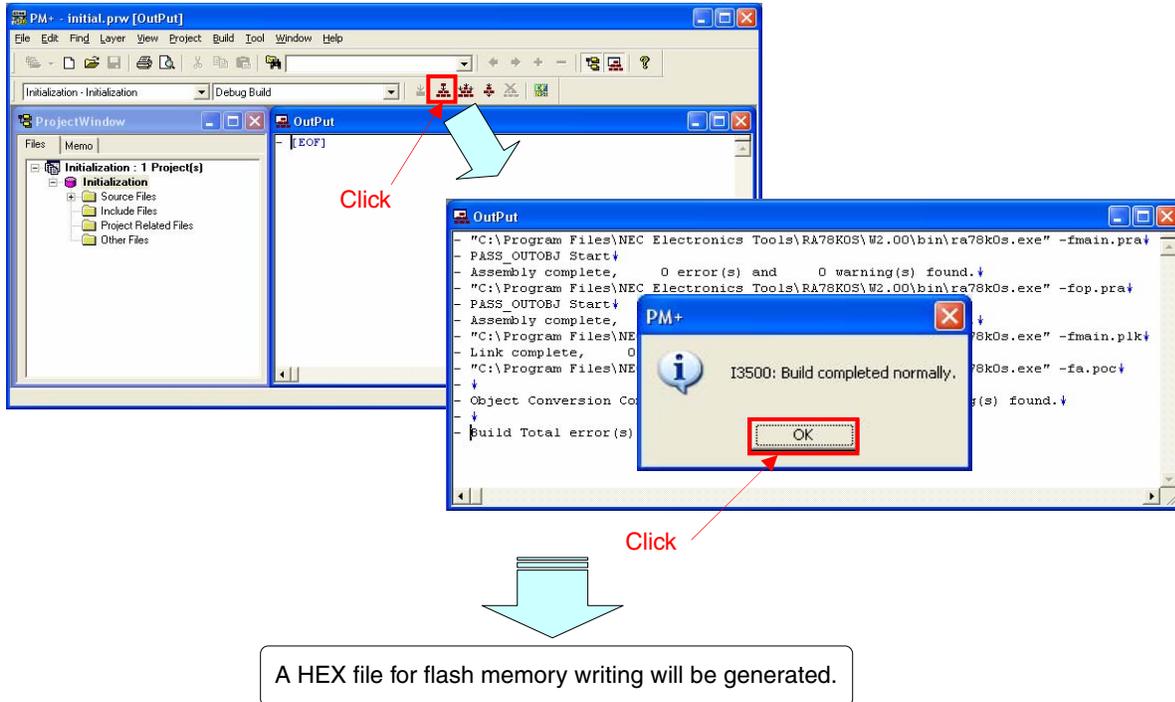
- (1) Start PM+.
- (2) Select "ad.prw" by clicking [Open Workspace] from the [File] menu and click [Open]. A workspace into which the source file will be automatically read will be created.
- (3) Select [Project Settings] from the [Project] menu. When the [Project Settings] window opens, select the name of the device to be used (the device with the largest ROM or RAM size will be selected by default), and click [OK].

Remark Screenshots of the Sample Program (Initial Settings) LED Lighting Switch Control are shown below.



- (4) Click  ([Build] button). When the source files are built normally, the message “I3500: Build completed normally.” will be displayed.
- (5) Click the [OK] button in the message dialog box. A HEX file for flash memory writing will be created.

Remark Screenshots of the Sample Program (Initial Settings) LED Lighting Switch Control are shown below.

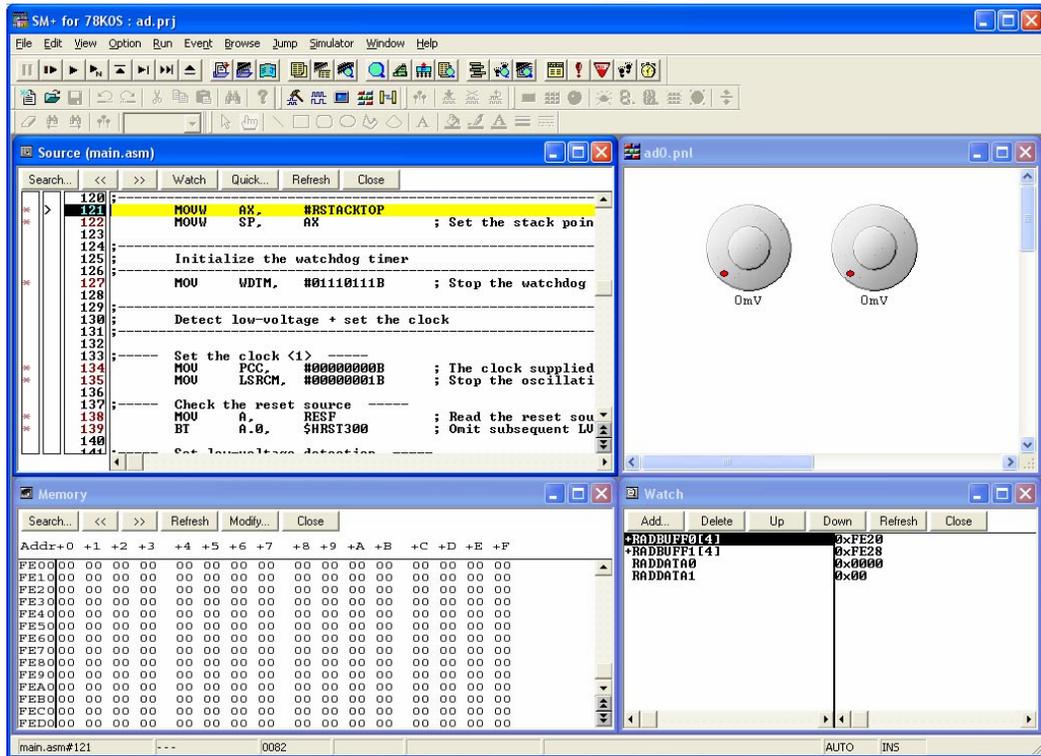


5.2 Operation with SM+

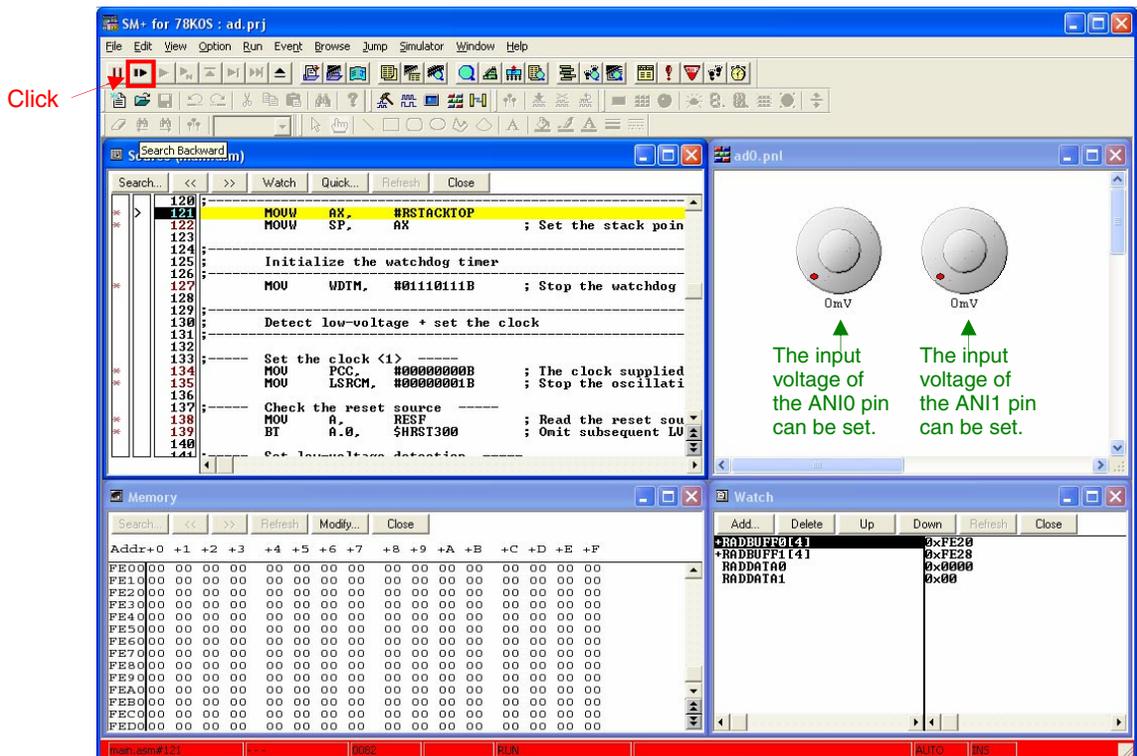
This section describes examples of checking the operation on the I/O panel window or timing chart window of SM+. For the details of how to operate SM+, refer to the [SM+ System Simulator Operation User's Manual](#).

- <R> (1) When SM+ for 78K0S/Kx1+ W1.02 (“SM+” hereafter) is used in the environment of PM+ Ver. 6.30, SM+ cannot be selected as the debugger. In this case, start SM+ via method (a) or (b) described below, while keeping PM+ running after completing building a project.
- (a) When starting SM+ in PM+
- <1> Select [Register Ex-tool] from the [Tool] menu and register “SM+ for 78K0S/Kx1+”.
 - <2> Select [Ex-tool Bar] from the [View] menu and add the SM+ icon to the PM+ toolbar.
 - <3> Click the SM+ icon and start SM+.
- (See the PM+ help for details on how to register external tools.)
- (b) When not starting SM+ in PM+
- Start SM+ from the Windows start menu.

- (2) The following screen will be displayed when SM+ is started. (This is a sample screenshot of when an assembly language source file downloaded by clicking the  icon was used.)

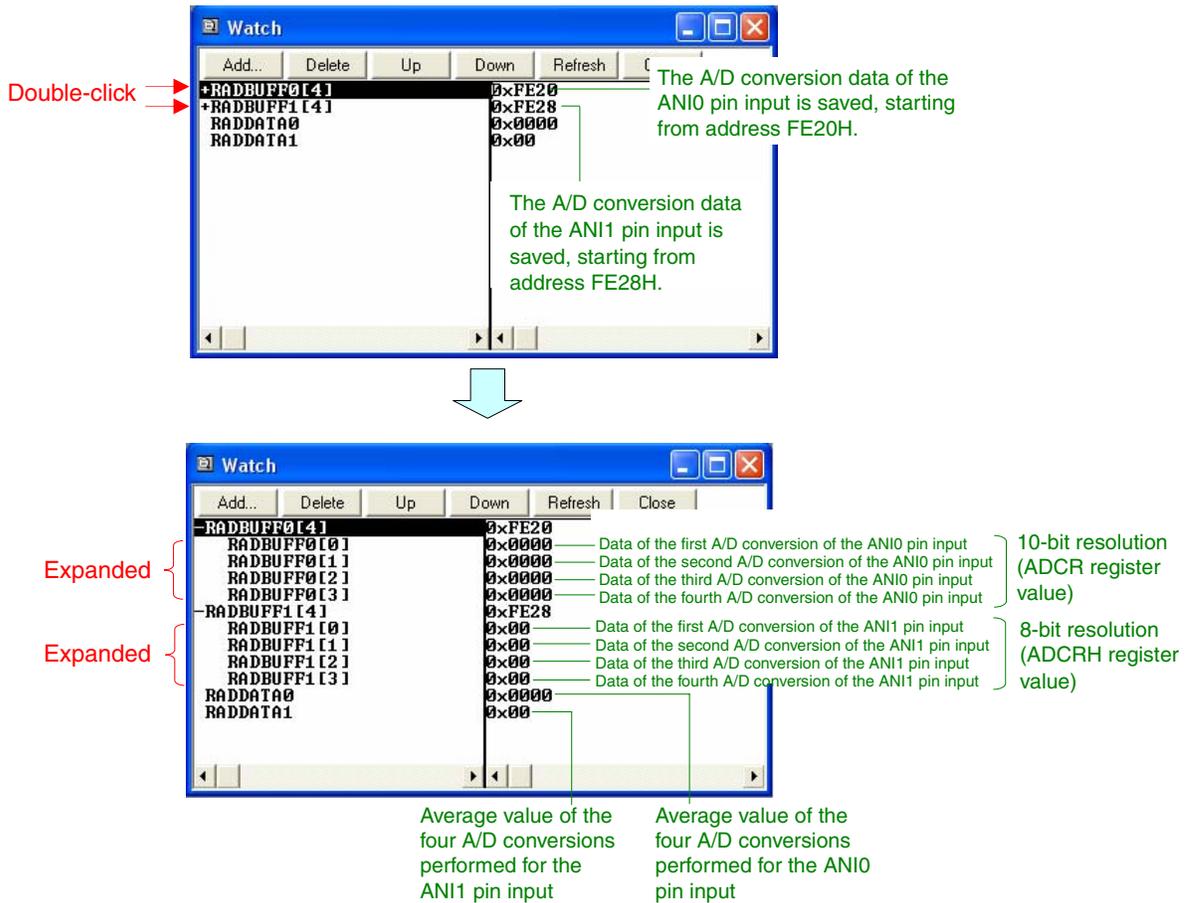


- (3) Click  ([Restart] button). The program will be executed after the CPU is reset and the following screen will be displayed.



This turns red during program execution.

- (4) The first character changes from a plus sign (“+”) to a minus sign (“-”), and the data will be expanded and displayed below “-RADBUFF0 [4]” and “-RADBUFF1 [4]”, by double-clicking “+RADBUFF0 [4]” and “+RADBUFF1 [4]” on the [Watch] window.



- (5) The input voltage can be changed by dragging the motion point (red dot) located at the level gauge on the I/O panel window during program execution. Check that the A/D conversion data on the [Watch] window and [Memory] window change as a result of changing the input voltage.

- Remarks**
- For the relation between the input voltages from the ANI0 and ANI1 pins, and the A/D conversion data, refer to [4.2 Input Voltage and A/D Conversion Result](#).
 - The A/D converter reference voltage input (AVREF) is set to 5 V by default. To change the AVREF voltage value, a level gauge must be added to the input panel. For the level gauge added, set the connection pin to “AVREF” and the maximum input value to an arbitrary value in the property settings. After setting the properties, set the AVREF voltage value by selecting “Input simulation” and dragging the motion point located on the level gauge on the I/O panel window.

Example 1: Input voltage from the ANI0 pin: 1,960 mV, input voltage from the ANI1 pin: 0 mV

I/O Panel Window

[Watch] Window

[Memory] Window

Addr	+0	+1	+2	+3	+4	+5	+6	+7	+8	+9	+A	+B	+C	+D	+E	+F
FE00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
FE10	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
FE20	91	01	91	01	91	01	91	01	00	00	00	00	91	01	00	00
FE30	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
FE40	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
FEB0	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
FEC0	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
FED0	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00

Example 2: Input voltage from the ANI0 pin: 1,960 mV, input voltage from the ANI1 pin: 1,960 mV

I/O Panel Window

[Watch] Window

[Memory] Window

CHAPTER 6 RELATED DOCUMENTS

Document Name		Japanese/English
78K0S/KU1+ User's Manual		PDF
78K0S/KY1+ User's Manual		PDF
78K0S/KA1+ User's Manual		PDF
78K0S/KB1+ User's Manual		PDF
78K/0S Series Instructions User's Manual		PDF
RA78K0S Assembler Package User's Manual	Language	PDF
	Operation	PDF
CC78K0S C Compiler User's Manual	Language	PDF
	Operation	PDF
PM+ Project Manager User's Manual		PDF
SM+ System Simulator Operation User's Manual		PDF
Flash Programming Manual (Basic) MINICUBE2 version	78K0S/KU1+	PDF
	78K0S/KY1+	PDF
	78K0S/KA1+	PDF
	78K0S/KB1+	PDF
78K0S/Kx1+ Application Note	Sample Program Startup Guide	PDF
	Sample Program (Initial Settings) LED Lighting Switch Control	PDF
	Sample Program (Interrupt) External Interrupt Generated by Switch Input	PDF
	Sample Program (Low-Voltage Detection) Reset Generation During Detection at Less than 2.7 V	PDF

<R>

APPENDIX A PROGRAM LIST

As a program list example, the 78K0S/KB1+ microcontroller source program is shown below.

● main.asm (Assembly language version)

```

;*****
;
;   NEC Electronics      78K0S/KB1+
;
;*****
;   78K0S/KB1+ Sample program
;*****
;   A/D converter
;*****
;<<History>>
;   2007.8.-- Release
;*****
;
;<<Overview>>
;
;This sample program presents an example of using the A/D converter. A/D
;conversion is performed four times for the analog input to the ANI0 pin
;and ANI1 pin, and the conversion results are saved into the RAM area.
;The A/D conversion results are read by using polling processing of the
;INTAD interrupt request flag. Furthermore, A/D conversion data of the
;ANI0 pin is saved in 10-bit resolution by reading the ADCR register, and
;the A/D conversion data of the ANI1 pin is saved in 8-bit resolution by
;reading the ADCRH register. The average value of each data is calculated
;and saved into the RAM area.
;
;
; <Principal setting contents>
;
; - Stop the watchdog timer operation
; - Set the low-voltage detection voltage (VLVI) to 4.3 V +/-0.2 V
; - Generate an internal reset signal (low-voltage detector) when VDD < VLVI
after VDD >= VLVI
; - Set the CPU clock to 8 MHz
; - Set the clock supplied to the peripheral hardware to 8 MHz
; - Set the A/D converter conversion time to 9.0 us
;
;
; <A/D conversion results and data storage location of the average values>
;
;
; +-----+
; | Label | Data | Data Type | A/D Conversion |
; | Name  | Length | | Port |
; +-----+
; | RADBUFF0 | 16 bits | 10-bit A/D conversion data (1st time) | P20/ANI0 |
; |          | 16 bits | 10-bit A/D conversion data (2nd time) | P20/ANI0 |
; |          | 16 bits | 10-bit A/D conversion data (3rd time) | P20/ANI0 |
; |          | 16 bits | 10-bit A/D conversion data (4th time) | P20/ANI0 |
; +-----+
; | RADBUFF1 | 8 bits | 8-bit A/D conversion data (5th time) | P21/ANI1 |
; |          | 8 bits | 8-bit A/D conversion data (6th time) | P21/ANI1 |
; |          | 8 bits | 8-bit A/D conversion data (7th time) | P21/ANI1 |
; +-----+

```

```

; |      | 8 bits| 8-bit A/D conversion data (8th time)| P21/ANI1 |
; |-----|-----|-----|-----|
; |RADATA0|16 bits| Average value of the 1st to 4th data| - |
; |RADATA1| 8 bits| Average value of the 5th to 8th data| - |
; +-----+-----+-----+-----+
;
;
; <<I/O port settings>>
;
; Input: P20, P21
; Output: P00-P03, P22, P23, P30-P33, P40-P47, P120-P123, P130
; # All unused ports are set as the output mode.
;
;*****
;=====
;
; Vector table
;
;=====
XVCT  CSEG  AT      0000H
      DW    IRESET ;(00) RESET
      DW    IRESET ;(02) --
      DW    IRESET ;(04) --
      DW    IRESET ;(06) INTLVI
      DW    IRESET ;(08) INTP0
      DW    IRESET ;(0A) INTP1
      DW    IRESET ;(0C) INTTMH1
      DW    IRESET ;(0E) INTTM000
      DW    IRESET ;(10) INTTM010
      DW    IRESET ;(12) INTAD
      DW    IRESET ;(14) --
      DW    IRESET ;(16) INTP2
      DW    IRESET ;(18) INTP3
      DW    IRESET ;(1A) INTTM80
      DW    IRESET ;(1C) INTSRE6
      DW    IRESET ;(1E) INTSR6
      DW    IRESET ;(20) INTST6
;=====
;
; Define the RAM
;
;=====
DRAM  DSEG  SADDRP
RADBUF0: DS   8 ; For storing the 10-bit A/D conversion results
RADBUF1: DS   4 ; For storing the 8-bit A/D conversion results
RADATA0: DS   2 ; For storing the average value of the 10-bit
A/D conversion results
RADATA1: DS   1 ; For storing the average value of the 8-bit A/D
conversion results
;=====
;
; Define the memory stack area
;
;=====
DSTK  DSEG  AT      0FEE0H

```

```

RSTACKEND: DS    20H           ; Memory stack area = 32 bytes
RSTACKTOP:           ; Start address of the memory stack area = FF00H

;*****
;
;   Initialization after RESET
;
;*****
XMAIN CSEG  UNIT
IRESET:
;-----
;   Initialize the stack pointer
;-----
    MOVW  AX,   #RSTACKTOP
    MOVW  SP,   AX           ; Set the stack pointer

;-----
;   Initialize the watchdog timer
;-----
    MOV   WDTM, #01110111B ; Stop the watchdog timer operation

;-----
;   Detect low-voltage + set the clock
;-----

;----- Set the clock <1> -----
    MOV   PCC, #00000000B ; The clock supplied to the CPU (fcpu) = fxp (=
fx/4 = 2 MHz)
    MOV   LSRM, #00000001B ; Stop the oscillation of the low-speed
internal oscillator

;----- Check the reset source -----
    MOV   A,   RESF           ; Read the reset source
    BT   A.0,  $HRST300      ; Omit subsequent LVI-related processing and go
to SET_CLOCK during LVI reset

;----- Set low-voltage detection -----
    MOV   LVIS, #00000000B ; Set the low-voltage detection level (VLVI) to
4.3 V +/-0.2 V
    SET1  LVION              ; Enable the low-voltage detector operation

    MOV   A,   #40           ; Assign the 200 us wait count value
;----- 200 us wait -----
HRST100:
    DEC   A
    BNZ  $HRST100           ; 0.5[us/clock] x 10[clock] x 40[count] = 200[us]

;----- VDD >= VLVI wait processing -----
HRST200:
    NOP
    BT   LVIF, $HRST200     ; Branch if VDD < VLVI

    SET1  LVIMD              ; Set so that an internal reset signal is
generated when VDD < VLVI

;----- Set the clock <2> -----
HRST300:
    MOV   PPCC, #00000000B ; The clock supplied to the peripheral hardware
(fxp) = fx (= 8 MHz)

```

```

; -> The clock supplied to the CPU (fcpu) = fxp
= 8 MHz

;-----
; Initialize the port 0
;-----
MOV    P0,    #00000000B ; Set output latches of P00-P03 as low
MOV    PM0,   #11110000B ; Set P00-P03 as output mode

;-----
; Initialize the port 2
;-----
MOV    P2,    #00000000B ; Set output latches of P20-P23 as low
MOV    PMC2,  #00000011B ; Set P20 and P21 to A/D converter mode
MOV    PM2,   #11110011B ; Set P22 and P23 as output mode, P20 and P21 as
input mode

;-----
; Initialize the port 3
;-----
MOV    P3,    #00000000B ; Set output latches of P30-P33 as low
MOV    PM3,   #11110000B ; Set P30-P33 as output mode

;-----
; Initialize the port 4
;-----
MOV    P4,    #00000000B ; Set output latches of P40-P47 as low
MOV    PM4,   #00000000B ; Set P40-P47 as output mode

;-----
; Initialize the port 12
;-----
MOV    P12,   #00000000B ; Set output latches of P120-P123 as low
MOV    PM12,  #11110000B ; Set P120-P123 as output mode

;-----
; Initialize the port 13
;-----
MOV    P13,   #00000001B ; Set output latch of P130 as high

;-----
; Set the A/D converter
;-----
MOV    ADM,   #00100000B ; A/D conversion time = 72/fxp (= 9.0 us)

;*****
;
; Main loop
;
;*****
MMAINLOOP:

;-----
; ANI0 pin A/D conversion processing (save the conversion results in 10-
bit resolution)
;-----
MOVW   HL,    #RADBUFF0 ; Specify the table address for storing the 10-
bit A/D conversion data
MOV    B,     #4 ; Specify the number of A/D conversions

```

```

SET1  ADCE                ; Enable comparator operation
MOV   ADS, #00H          ; Initialize the analog input channel to ANI0
NOP
NOP
SET1  ADCS                ; Start A/D conversion operation

LMLP100:
;----- Wait for A/D conversion completion -----
CLR1  ADIF                ; Clear the INTAD interrupt request
LMLP150:
NOP
BF    ADIF, $LMLP150     ; Wait for an INTAD interrupt

;----- Store the conversion data -----
MOVW  AX,  ADCR           ; Read the 10-bit A/D conversion data
MOV   [HL+1], A          ; Store the higher 2 bits
XCH  A, X
MOV   [HL], A            ; Store the lower 8 bits
INC   L                  ; Increment the table address by 2
INC   L
DBNZ  B, $LMLP100        ; Branch if the number of A/D conversions < 4

;-----
; ANI1 pin A/D conversion processing (save the conversion results in 8-bit
; resolution)
;-----
MOVW  HL, #RADBUFF1      ; Specify the table address for storing the 8-
bit A/D conversion data
MOV   B, #4              ; Specify the number of A/D conversions

MOV   ADS, #01H          ; Set the analog input channel to ANI1

LMLP200:
;----- Wait for A/D conversion completion -----
CLR1  ADIF                ; Clear the INTAD interrupt request
LMLP250:
NOP
BF    ADIF, $LMLP250     ; Wait for an INTAD interrupt
CLR1  ADIF                ; Clear the INTAD interrupt request

;----- Store the conversion data -----
MOV   A,  ADCRH           ; Read the 8-bit A/D conversion data
MOV   [HL], A            ; Store the A/D conversion data
INC   L                  ; Increment the table address by 1
DBNZ  B, $LMLP200        ; Branch if the number of A/D conversions < 4

CLR1  ADCS                ; Stop A/D conversion operation
CLR1  ADCE                ; Stop comparator operation

;-----
; Calculate the average value of the 10-bit A/D conversion data (ANI0 pin)
;-----
MOVW  HL, #RADBUFF0      ; Specify the table address for storing the 10-
bit A/D conversion data
MOVW  AX, #0000H         ; Clear the AX register

```

```

;----- Add -----
      MOV   B,    #4           ; Specify the number of additions
LMLP300:
      XCH   A,    X
      ADD   A,    [HL]        ; Add the lower 8 bits
      XCH   A,    X
      ADDC  A,    [HL+1]      ; Add the higher 2 bits (including carried lower
bits)
      INC   L                ; Increment the table address by 2
      INC   L
      DBNZ  B,    $LMLP300    ; Branch if the number of additions < 4

;----- Calculate the average value -----
      MOV   B,    #2           ; Specify the number of right-shifts (= x1/2)
LMLP350:
      ROR   A,    1           ; Right-shift the higher bits by 1
      XCH   A,    X
      RORC  A,    1           ; Right-shift the lower bits by 1 (including
shifting of higher bits)
      XCH   A,    X
      DBNZ  B,    $LMLP350    ; Branch if the number of right-shifts < 2

      AND   A,    #00000011B  ; Mask bits other than higher bits 0 and 1
      MOVW  RADATA0, AX       ; Store the average value (10-bit data) into
RADATA0

;-----
; Calculate the average value of the 8-bit A/D conversion data (ANI1 pin)
;-----
      MOVW  HL,    #RADBUFF1   ; Specify the table address for storing the 8-
bit A/D conversion data
      MOVW  AX,    #0000H     ; Clear the AX register

;----- Add -----
      MOV   B,    #4           ; Specify the number of additions
LMLP400:
      ADD   A,    [HL]        ; Add
      BNC   $LMLP420         ; Branch if no bits are carried
      INC   X                ; Increment the higher bits by 1
LMLP420:
      INC   L                ; Increment the table address by 1
      DBNZ  B,    $LMLP400    ; Branch if the number of additions < 4

;----- Calculate the average value -----
      MOV   B,    #2           ; Specify the number of right-shifts (= x1/2)
LMLP450:
      XCH   A,    X
      ROR   A,    1           ; Right-shift the higher bits by 1
      XCH   A,    X
      RORC  A,    1           ; Right-shift the lower bits by 1 (including
shifting of higher bits)
      DBNZ  B,    $LMLP450    ; Branch if the number of right-shifts < 2

      MOV   RADATA1, A        ; Store the average value (8-bit data) to
RADATA1

      BR    !MMAINLOOP       ; Go to the MMAINLOOP

end

```

● main.c (C language version)

```

/*****
    NEC Electronics      78K0S/KB1+

*****
    78K0S/KB1+ Sample program
*****
    A/D converter
*****
<<History>>
    2007.8.-- Release
*****

```

<<Overview>>

This sample program presents an example of using the A/D converter. A/D conversion is performed four times for the analog input to the ANI0 pin and ANI1 pin, and the conversion results are saved into the RAM area. The A/D conversion results are read by using polling processing of the INTAD interrupt request flag. Furthermore, A/D conversion data of the ANI0 pin is saved in 10-bit resolution by reading the ADCR register, and the A/D conversion data of the ANI1 pin is saved in 8-bit resolution by reading the ADCRH register. The average value of each data is calculated and saved into the RAM area.

<Principal setting contents>

- Stop the watchdog timer operation
- Set the low-voltage detection voltage (VLVI) to 4.3 V +/-0.2 V
- Generate an internal reset signal (low-voltage detector) when VDD < VLVI after VDD >= VLVI
- Set the CPU clock to 8 MHz
- Set the clock supplied to the peripheral hardware to 8 MHz
- Set the A/D converter conversion time to 9.0 us

<A/D conversion results and data storage location of the average values>

Variable Name	Data Length	Data Type	A/D Conversion Port
g_ushnAdBuff0	16 bits	10-bit A/D conversion data (1st time)	P20/ANI0
	16 bits	10-bit A/D conversion data (2nd time)	P20/ANI0
	16 bits	10-bit A/D conversion data (3rd time)	P20/ANI0
	16 bits	10-bit A/D conversion data (4th time)	P20/ANI0
g_ucAdBuff1	8 bits	8-bit A/D conversion data (5th time)	P21/ANI1
	8 bits	8-bit A/D conversion data (6th time)	P21/ANI1
	8 bits	8-bit A/D conversion data (7th time)	P21/ANI1
	8 bits	8-bit A/D conversion data (8th time)	P21/ANI1
g_ushnAdData0	16 bits	Average value of the 1st to 4th data	-
g_unAdData1	8 bits	Average value of the 5th to 8th data	-

<<I/O port settings>>

Input: P20, P21

Output: P00-P03, P22, P23, P30-P33, P40-P47, P120-P123, P130

All unused ports are set as the output mode.

*****/

/*=====

Preprocessing directive (#pragma)

=====*/

```
#pragma SFR /* SFR names can be described at the C
source level */
```

```
#pragma NOP /* NOP instructions can be described at
the C source level */
```

/*=====

Define the global variables

=====*/

```
sreg static unsigned short int g_ushnAdBuff0[4]; /* 16-bit variable table
for storing the 10-bit A/D conversion data */
```

```
sreg static unsigned char g_ucAdBuff1[4]; /* 8-bit variable table
for storing the 8-bit A/D conversion data */
```

```
sreg static unsigned short int g_ushnAdData0; /* 16-bit variable for
storing the average value of the 10-bit A/D conversion data */
```

```
sreg static unsigned char g_ucAdData1; /* 8-bit variable for
storing the average value of the 8-bit A/D conversion data */
```

/******

Initialization after RESET

*****/

```
void hdwinit(void){
    unsigned char ucCnt200us; /* 8-bit variable for 200 us wait */
```

/*-----

Initialize the watchdog timer + detect low-voltage + set the clock

-----*/

```
/* Initialize the watchdog timer */
```

```
WDTM = 0b01110111; /* Stop the watchdog timer operation */
```

```
/* Set the clock <1> */
```

```
PCC = 0b00000000; /* The clock supplied to the CPU (fcpu) =
fxp (= fx/4 = 2 MHz) */
```

```
LSRCM = 0b00000001; /* Stop the oscillation of the low-speed
internal oscillator */
```

```
/* Check the reset source */
```

```
if (!(RESF & 0b00000001)){ /* Omit subsequent LVI-related processing
during LVI reset */
```

```
/* Set low-voltage detection */
```

```

        LVIS = 0b00000000;    /* Set the low-voltage detection level
(VLVI) to 4.3 V +-0.2 V */
        LVION = 1;           /* Enable the low-voltage detector operation */

        for (ucCnt200us = 0; ucCnt200us < 9; ucCnt200us++){ /* Wait of
about 200 us */
            NOP();
        }

        while (LVIF){        /* Wait for VDD >= VLVI */
            NOP();
        }

        LVIMD = 1;          /* Set so that an internal reset signal is
generated when VDD < VLVI */
    }

    /* Set the clock <2> */
    PPCC = 0b00000000;      /* The clock supplied to the peripheral hardware
(fxp) = fx (= 8 MHz)
                                -> The clock supplied to the CPU (fcpu) = fxp
= 8 MHz */

/*-----
    Initialize the port 0
-----*/
    P0   = 0b00000000;      /* Set output latches of P00-P03 as low */
    PM0  = 0b11110000;      /* Set P00-P03 as output mode */

/*-----
    Initialize the port 2
-----*/
    P2   = 0b00000000;      /* Set output latches of P20-P23 as low */
    PMC2 = 0b00000011;      /* Set P20 and P21 to A/D converter mode
*/
    PM2  = 0b11110011;      /* Set P22 and P23 as output mode, P20 and
P21 as input mode */

/*-----
    Initialize the port 3
-----*/
    P3   = 0b00000000;      /* Set output latches of P30-P33 as low */
    PM3  = 0b11110000;      /* Set P30-P33 as output mode */

/*-----
    Initialize the port 4
-----*/
    P4   = 0b00000000;      /* Set output latches of P40-P47 as low */
    PM4  = 0b00000000;      /* Set P40-P47 as output mode */

/*-----
    Initialize the port 12
-----*/
    P12  = 0b00000000;      /* Set output latches of P120-P123 as low
*/
    PM12 = 0b11110000;      /* Set P120-P123 as output mode */

/*-----
    Initialize the port 13

```

```

-----*/
    P13    = 0b00000001;          /* Set output latch of P130 as high */
/*-----
    Set the A/D converter
-----*/
    ADM    = 0b00100000;          /* A/D conversion time = 72/fxp (= 9.0 us)
*/

    return;
}

/*****

    Main loop

*****/
void main(void){

unsigned char ucTimes;           /* 8-bit variable for counting the number of A/D
conversions */
unsigned short int ushnAdSum; /* 16-bit variable for adding A/D conversion
data */

    while (1)
    {
/*-----
        ANI0 pin A/D conversion processing (save the conversion results in 10-
bit resolution)
-----*/
            ADCE = 1;              /* Enable comparator operation */
            ADS = 0x00;            /* Initialize the analog input channel to
ANI0 */
            NOP();
            NOP();
            ADCS = 1;              /* Start A/D conversion operation */

            for (ucTimes = 0; ucTimes < 4; ucTimes++) /* Perform A/D
conversion processing four times */
            {
                ADIF = 0;          /* Clear the INTAD interrupt request
*/

                while (!ADIF)      /* Wait for an INTAD interrupt */
                {
                    NOP();
                }

                g_ushnAdBuff0[ucTimes] = ADCR;          /* Store the 10-bit A/D
conversion data */
            }

/*-----
        ANI1 pin A/D conversion processing (save the conversion results in 8-bit
resolution)
-----*/
            ADS = 0x01;            /* Set the analog input channel to ANI1 */

```

```

        for (ucTimes = 0; ucTimes < 4; ucTimes++) /* Perform A/D
conversion processing four times */
        {
            ADIF = 0;          /* Clear the INTAD interrupt request */

            while (!ADIF)     /* Wait for an INTAD interrupt */
            {
                NOP();
            }

            g_ucAdBuff1[ucTimes] = ADCRH; /* Store the 8-bit A/D
conversion data */
        }

        ADCS = 0;            /* Stop A/D conversion operation */
        ADCE = 0;            /* Stop comparator operation */

/*-----
        Calculate the average value of the 10-bit A/D conversion data (ANI0 pin)
-----*/
        ushnAdSum = 0x0000; /* Clear the variable for adding the A/D
conversion data */

        for (ucTimes = 0; ucTimes < 4; ucTimes++) /* Add the data of the
four A/D conversions */
        {
            ushnAdSum += g_ushnAdBuff0[ucTimes]; /* Add the 10-bit
A/D conversion data */
        }

        g_ushnAdData0 = ushnAdSum >> 2; /* Save the average value of
the 10-bit A/D conversion data */

/*-----
        Calculate the average value of the 8-bit A/D conversion data (ANI1 pin)
-----*/
        ushnAdSum = 0x0000; /* Clear the variable for adding the A/D
conversion data */

        for (ucTimes = 0; ucTimes < 4; ucTimes++) /* Add the data of the
four A/D conversions */
        {
            ushnAdSum += g_ucAdBuff1[ucTimes]; /* Add the 8-bit A/D
conversion data */
        }

        g_ucAdData1 = ushnAdSum >> 2; /* Save the average value of
the 8-bit A/D conversion data */
    }
}

```

● op.asm (Common to assembly language and C language versions)

```

;=====
;
;   Option byte
;
;=====

```

```

OPBT      CSEG      AT      0080H
          DB      10011100B      ; Option byte area
;
;          ||||
;          |||+----- Low-speed internal oscillator can be
stopped by software
;          |++----- High-speed internal oscillation clock (8
MHz) is selected for system clock source
;          +----- P34/RESET pin is used as RESET pin

          DB      11111111B      ; Protect byte area (for the self programming
mode)
;          |||||
;          ++++++----- All blocks can be written or erased

end

```

APPENDIX B REVISION HISTORY

The mark "<R>" shows major revised points. The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what." field.

Edition	Date Published	Page	Revision
1st edition	December 2007	–	–
2nd edition	September 2008	p.20	CHAPTER 5 OPERATION CHECK USING SYSTEM SIMULATOR SM+ • Modification of description in Caution ((as of October 2007) → (as of July 2008))
		pp.20 to 22	Modification of 5.1 Building the Sample Program
		p.22	5.2 Operation with SM+ • Addition of (1)
		p.27	CHAPTER 6 RELATED DOCUMENTS • Addition of Flash Programming Manual (Basic) MINICUBE2 version

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